

RoHS

COMPLIANT

4N10L12-VB Datasheet

N-Channel 100-V (D-S) MOSFET

PRODUCT SUMMARY				
V _{DS} (V)	R _{DS(on)} (Ω)	I _D (A)		
100	0.0085 at V _{GS} = 10 V	85		
	0.0105 at V _{GS} = 4.5 V	70		

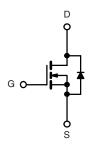
FEATURES

- TrenchFET[®] Power MOSFET ٠
- 100 % Rg Tested
- 100 % UIS Tested

APPLICATIONS

- Primary Side Switch
- Isolated DC/DC Converter





N-Channel MOSFET

ABSOLUTE MAXIMUM RATINGS $T_A = 25 \text{ °C}$, unless otherwise noted						
Parameter			Limit	Unit		
Drain-Source Voltage			100	v		
Gate-Source Voltage			± 20	v		
Continuous Drain Current (T _J = 150 °C)	T _C = 25 °C	la.	85			
	T _C = 125 °C	I _D	75 ^a	^		
Pulsed Drain Current	I _{DM}	300	A			
Avalanche Current	L = 0.1 mH	I _{AS}	75			
Single Pulse Avalanche Energy ^b	L = 0.1 mn	E _{AS}	280	mJ		
Maximum Power Dissipation ^b	T _C = 25 °C	PD	176	W		
	T _A = 25 °C	' U	3.75	vv		
Operating Junction and Storage Temperature Range		T _J , T _{stg}	- 55 to 175	°C		

THERMAL RESISTANCE RATINGS						
Parameter		Symbol	Typical	Maximum	Unit	
Maximum Junction-to-Ambient ^b	Steady State	R _{thJA}	40	50	°C/W	
Maximum Junction-to-Case	Sleady Slale	R _{thJC}	0.85	1.1	0/10	

Notes:

a. Package limited.

b. Surface mounted on 1" x 1" FR4 board.

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.





Parameter	Symbol	Test Conditions	Min.	Тур.	Max.	Unit	
Static		·					
Drain-Source Breakdown Voltage	V _{DS}	$V_{GS} = 0 \text{ V}, \text{ I}_{D} = 250 \mu\text{A}$	100			v	
Gate-Threshold Voltage	V _{GS(th)}	$V_{DS} = V_{GS}$, $I_D = 250 \ \mu A$			4	v	
Gate-Body Leakage	I _{GSS}	$V_{DS} = 0 V, V_{GS} = \pm 20 V$			± 100	nA	
		$V_{DS} = 100 \text{ V}, V_{GS} = 0 \text{ V}$			1		
Zero Gate Voltage Drain Current	I _{DSS}	$V_{DS} = 80 \text{ V}, V_{GS} = 0 \text{ V}, T_{J} = 125 \text{ °C}$			50	μA	
		$V_{DS} = 80 \text{ V}, \text{ V}_{GS} = 0 \text{ V}, \text{ T}_{J} = 175^{\circ}\text{C}$	250		250	1	
On-State Drain Current ^a	I _{D(on)}	$V_{DS} = \ge 5 \text{ V}, V_{GS} = 10 \text{ V}$	50			А	
		$V_{GS} = 10 \text{ V}, \text{ I}_{D} = 20 \text{ A}$	0.0085				
	Brack	V _{GS} = 4.5 V, I _D = 20 A		0.0105		Ω	
Drain-Source On-State Resistance ^a	R _{DS(on)}	$V_{GS} = 10 \text{ V}, \text{ I}_{D} = 20 \text{ A}, \text{ T}_{J} = 125 ^{\circ}\text{C}$		0.017			
		$V_{GS} = 10 \text{ V}, \text{ I}_{D} = 20 \text{ A}, \text{ T}_{J} = 175 ^{\circ}\text{C}$		0.022			
Forward Transconductance ^a	9 _{fs}	$V_{DS} = 15 \text{ V}, \text{ I}_{D} = 20 \text{ A}$	25			S	
Dynamic ^b			-				
Input Capacitance	C _{iss}			4000		pF	
Output Capacitance	C _{oss}	$V_{GS} = 0 V, V_{DS} = 25 V, f = 1 MHz$		565			
Reverse Transfer Capacitance	C _{rss}			205			
Total Gate Charge ^c	Qg			105	160		
Gate-Source Charge ^c	Q _{gs}	V_{DS} = 50 V, V_{GS} = 10 V, I_{D} = 45 A		17		nC	
Gate-Drain Charge ^c	Q _{gd}			23		1	
Turn-On Delay Time ^c	t _{d(on)}			12	25		
Rise Time ^c	t _r	V_{DD} = 20 V, R_L = 0.6 Ω		90	135	n 0	
Turn-Off DelayTime ^c	t _{d(off)}	$\text{I}_\text{D} \cong$ 45 A, V_GEN = 10 V, R_g = 2.5 Ω		55	85	ns	
Fall Time ^c	t _f			130	195		
Source-Drain Diode Ratings and Cha	racteristics T _C :	= 25 °C ^b					
Continuous Current	ا _S				85	А	
Pulsed Current	I _{SM}				140	A	
Forward Voltage ^a	V _{SD}	I _F = 45 A, V _{GS} = 0 V		1.0	1.5	V	
Reverse Recovery Time	t _{rr}			85	140	ns	
Peak Reverse Recovery Current	I _{RM(REC)}	I _F = 50 A, dl/dt = 100 A/μs		4.5	7	А	
Reverse Recovery Charge	Q _{rr}	7		0.17	0.35	μC	

Notes:

a. Pulse test; pulse width \leq 300 $\mu s,$ duty cycle \leq 2 %.

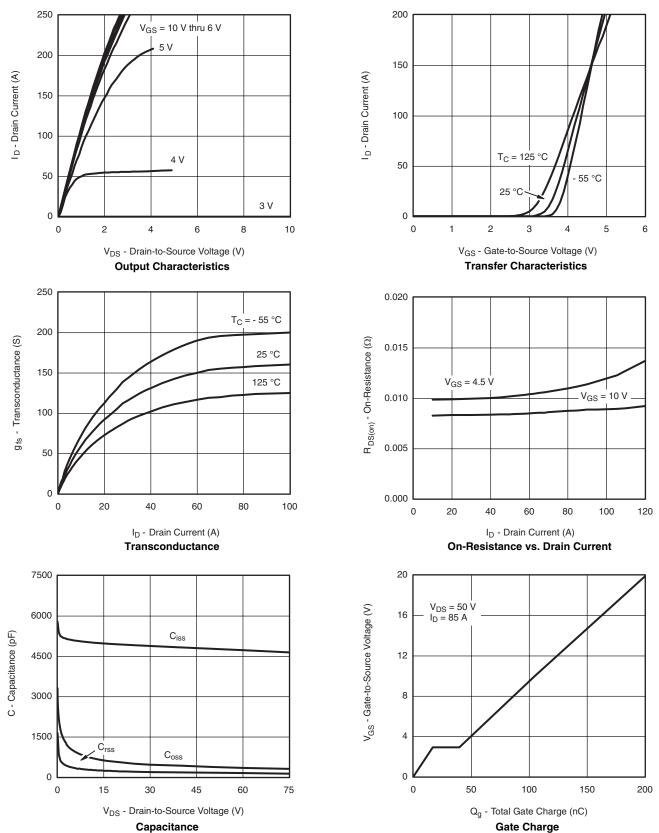
b. Guaranteed by design, not subject to production testing.

c. Independent of operating temperature.

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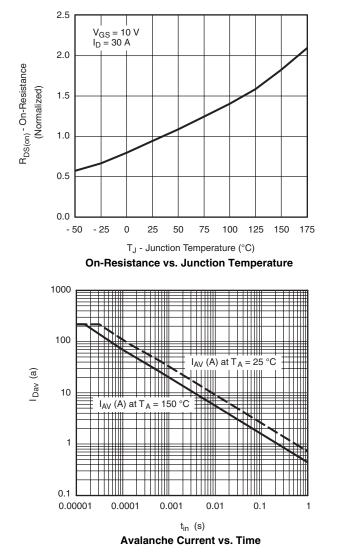


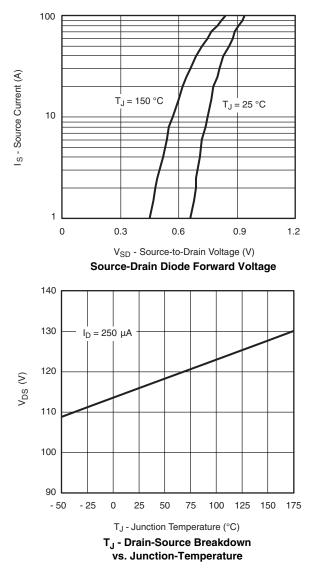
TYPICAL CHARACTERISTICS $T_A = 25 \text{ °C}$, unless otherwise noted





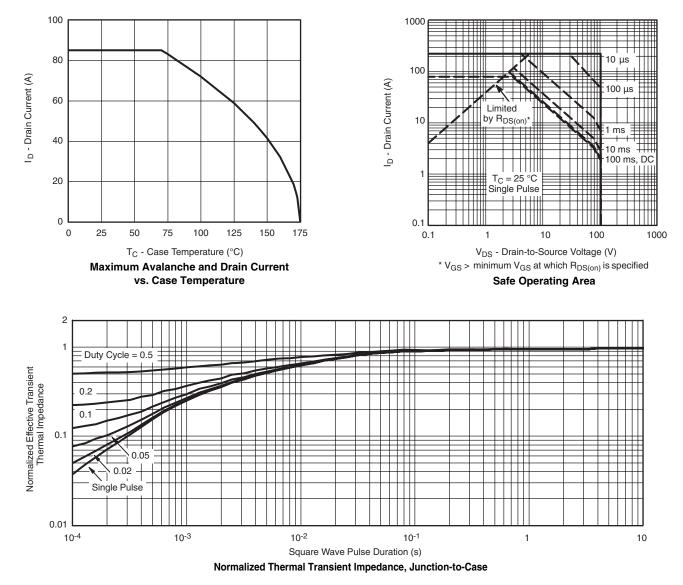
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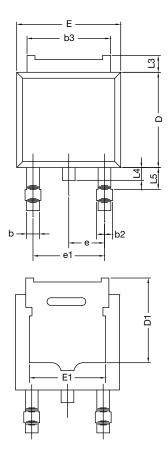


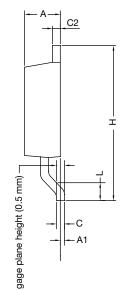
THERMAL RATINGS





TO-252AA CASE OUTLINE





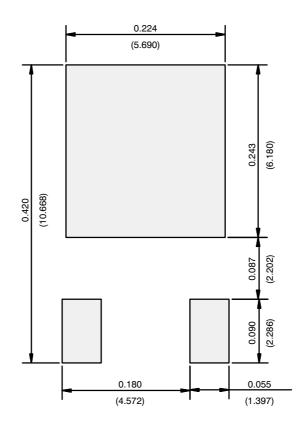
	MILLIMETERS		INC	HES
DIM.	MIN.	MAX.	MIN.	MAX.
А	2.18	2.38	0.086	0.094
A1	-	0.127	-	0.005
b	0.64	0.88	0.025	0.035
b2	0.76	1.14	0.030	0.045
b3	4.95	5.46	0.195	0.215
С	0.46	0.61	0.018	0.024
C2	0.46	0.89	0.018	0.035
D	5.97	6.22	0.235	0.245
D1	5.21	-	0.205	-
E	6.35	6.73	0.250	0.265
E1	4.32	-	0.170	-
Н	9.40	10.41	0.370	0.410
е	2.28 BSC		0.090 BSC	
e1	4.56 BSC		0.180 BSC	
L	1.40	1.78	0.055	0.070
L3	0.89	1.27	0.035	0.050
L4	-	1.02	-	0.040
L5	1.14	1.52	0.045	0.060
ECN: X12-0247-Rev. M, 24-Dec-12 DWG: 5347				

Note

• Dimension L3 is for reference only.



RECOMMENDED MINIMUM PADS FOR DPAK (TO-252)



Recommended Minimum Pads Dimensions in Inches/(mm)



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